



Bridgelux® SMD 5050 3W 9V

Product Data Sheet DS61

BXEP-27E 30E 35E 40E 45E 50E 57E 65E

SMD 5050



Introduction

The Bridgelux SMD 5050 high power LED is hot-color targeted which ensures that the LEDs fall within their specified color bin at the typical application conditions of 85°C. With its broad lumen coverage and wide range of CCT options, the SMD 5050 provides unparalleled design-in flexibility for indoor and outdoor lighting applications. The SMD 5050 is ideal as a drop in replacement for emitters with an industry standard 5.0mm x 5.0mm footprint.

Features

- Industry-standard 5050 footprint
- 3 bin color control enables tight color control
- Hot-color targeting ensures that color is within the ANSI bin at the typical application conditions of 85°C
- Enables 3- and 5-step MacAdam ellipse custom binning kits
- RoHS compliant and lead free
- Multiple CCT configurations for a wide range of lighting applications

Benefits

- · Lower operating and manufacturing cost
- Ease of design and rapid go-to-market
- Uniform consistent white light
- Reliable and constant white point
- · Environmentally friendly, complies with standards
- Design flexibility

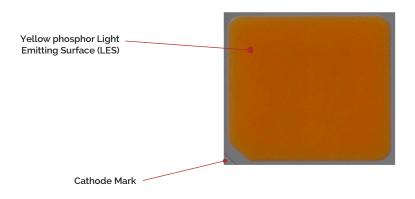


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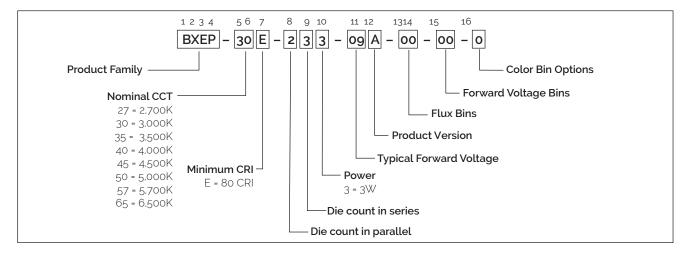
Product Feature Map

Bridgelux SMD LED products come in industry standard package sizes and follow ANSI binning standards. These LEDs are optimized for cost and performance, helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting applications.



Product Nomenclature

The part number designation for Bridgelux SMD 5050 is explained as follows:



Product Test Conditions

Bridgelux SMD 5050 LEDs are tested and binned with a 10ms pulse of 320mA at T_j (junction temperature)- T_{sp} (solder point temperature) =25°C. Forward voltage and luminous flux are binned at a T_j - T_{sp} -25°C, while color is hot targeted at a T_{sp} of 85°C.

The following product configurations are available:

Part Number16 N	Nominal CCT ²	CRI ^{3.5}	Nominal Drive Current	Forward Voltage⁴.₅ (V)			Typical Pulsed	Typical Power	Typical Efficacy
	(K)		(mA)	Min	Typical	Max	Flux (lm)⁴.⁵	(\\\/)	(lm/W)
BXEP-27E-233-09A-00-00-0	2700	80	320	8.5	9.3	10.2	389	3.0	131
BXEP-30E-233-09A-00-00-0	3000	80	320	8.5	9.3	10.2	401	3.0	135
BXEP-35E-233-09A-00-00-0	3500	80	320	8.5	9.3	10.2	412	3.0	138
BXEP-40E-233-09A-00-00-0	4000	80	320	8.5	9.3	10.2	430	3.0	144
BXEP-45E-233-09A-00-00-0	4500	80	320	8.5	9.3	10.2	435	3.0	146
BXEP-50E-233-09A-00-00-0	5000	80	320	8.5	9.3	10.2	435	3.0	146
BXEP-57E-233-09A-00-00-0	5700	80	320	8.5	9.3	10.2	435	3.0	146
BXEP-65E-233-09A-00-00-0	6500	80	320	8.5	9.3	10.2	432	3.0	145

Table 1: Selection Guide, Pulsed Measurement Data at 320mA ($T_i = T_{sn} = 25^{\circ}C$)

Table 2: Selection Guide, Stabilized DC Performance $(T_{so} = 85^{\circ}C)^{7.8}$

Part Number ¹⁶	Nominal CCT ² (K)	CRI ^{3.5} Current		Forward Voltage⁵ (V)			Typical DC Flux (lm)₅	Typical Power (W/)	Typical Efficacy (lm/W)
	(K)		(mA)	Min	Typical	Max		(W)	(un/w)
BXEP-27E-233-09A-00-00-0	2700	80	320	8.2	9.0	9.9	338	2.9	117
BXEP-30E-233-09A-00-00-0	3000	80	320	8.2	9.0	9.9	349	2.9	121
BXEP-35E-233-09A-00-00-0	3500	80	320	8.2	9.0	9.9	358	2.9	124
BXEP-40E-233-09A-00-00-0	4000	80	320	8.2	9.0	9.9	374	2.9	129
BXEP-45E-233-09A-00-00-0	4500	80	320	8.2	9.0	9.9	378	2.9	131
BXEP-50E-233-09A-00-00-0	5000	80	320	8.2	9.0	9.9	378	2.9	131
BXEP-57E-233-09A-00-00-0	5700	80	320	8.2	9.0	9.9	378	2.9	131
BXEP-65E-233-09A-00-00-0	6500	80	320	8.2	9.0	9.9	376	2.9	130

Notes for Table 1 & 2:

1. The last 7 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-00-0" denotes the full distribution of flux, forward voltage, and 7 SDCM color.

Example: BXEP-30E-233-09A-00-00-0 refers to the full distribution of flux, forward voltage, and color within a 3000K 7-step ANSI standard chromaticity region with a minimum of 80CRI, 2x3 die configuration, 3w power, 9.3V typical forward voltage.

- 2. Product CCT is hot targeted at T_{sp} = 85°C. Nominal CCT as defined by ANSI C78.377-2011.
- 3. Listed CRIs are minimum values and include test tolerance.
- 4. Products tested under pulsed condition (10ms pulse width) at nominal drive current where T_i=T_{sp}=25°C.
- 5. Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the SMD 5050.
- 6. Refer to Table 6 and Table 7 for Bridgelux SMD 5050 Luminous Flux Binning and Forward Voltage Binning information.
- 7. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.
- 8. Typical performance is estimated based on operation under DC (direct current) with LED emitter mounted onto a heat sink with thermal interface material and the solder point temperature maintained at 85°C. Based on Bridgelux test setup, values may vary depending on the thermal design of the luminaire and/or the exposed environment to which the product is subjected.

SMD 5050 LEDs are tested to the specifications shown using the nominal drive currents in Table 1. SMD 5050 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux ² T _{sp} = 25°C (lm)	Typical DC Flux ³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		80	8.3	0.7	108	95	163
		160	8.7	1.4	209	187	149
BXEP-27E-233-09A-00-00-0	80	240	9.1	2.2	303	268	138
		320	9.3	3.0	389	338	131
		480	10.0	4.8	541	454	113
		80	8.3	0.7	111	98	168
		160	8.7	1.4	215	192	154
BXEP-30E-233-09A-00-00-0	80	240	9.1	2.2	312	277	143
		320	9.3	3.0	401	349	135
		480	10.0	4.8	558	468	117
		80	8.3	0.7	114	100	172
		160	8.7	1.4	221	198	158
BXEP-35E-233-09A-00-00-0	80	240	9.1	2.2	321	284	147
		320	9.3	3.0	412	358	138
		480	10.0	4.8	573	480	120
		80	8.3	0.7	119	105	180
		160	8.7	1.4	231	206	165
BXEP-40E-233-09A-00-00-0	80	240	9.1	2.2	335	297	153
		320	9.3	3.0	430	374	144
		480	10.0	4.8	598	501	125
		80	8.3	0.7	121	106	182
		160	8.7	1.4	234	209	167
BXEP-45E-233-09A-00-00-0	80	240	9.1	2.2	338	300	155
		320	9.3	3.0	435	378	146
		480	10.0	4.8	605	507	127

Table 3: Performance at Commonly Used Drive Currents

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

2. Bridgelux maintains a \pm 7.5% tolerance on flux measurements.

3. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux ² T _{sp} = 25°C (lm)	Typical DC Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		80	8.3	0.7	121	106	182
		160	8.7	1.4	234	209	167
BXEP-50E-233-09A-00-00-0	80	240	9.1	2.2	338	300	155
		320	9.3	3.0	435	378	146
		480	10.0	4.8	605	507	127
	80	80	8.3	0.7	121	106	182
		160	8.7	1.4	234	209	167
BXEP-57E-233-09A-00-00-0		240	9.1	2.2	338	300	155
		320	9.3	3.0	435	378	146
		480	10.0	4.8	605	507	127
		80	8.3	0.7	120	105	181
		160	8.7	1.4	232	207	166
BXEP-65E-233-09A-00-00-0	80	240	9.1	2.2	336	298	154
		320	9.3	3.0	432	376	145
		480	10.0	4.8	601	504	126

Table 3: Performance at Commonly Used Drive Currents (Continued)

Notes for Table 3:

1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

2. Bridgelux maintains a \pm 7.5% tolerance on flux measurements.

3. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Electrical Characteristics

Table 4: Electrical Characteristics

	Drive Current	Fo	orward Voltag (V) ^{2,3}	ge	Typical Temperature Coefficient	Typical Thermal Resistance	
Part Number ¹	(mA)	Minimum	Typical	Maximum	of Forward Voltage ∆V,∕∆T (mV∕°C)	Junction to Solder Point⁴ R _{j-sp} (°C∕W)	
BXEP-xxE-233-09A-00-00-0	320	8.5	9.3	10.2	-4.3	3.3	

Notes for Table 4:

1. The last 7 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-00-0" denotes the full distribution of flux, forward voltage, and 7 SDCM color.

Example: BXEP-30E-233-09A-00-00-0 refers to the full distribution of flux, forward voltage, and color within a 3000K 7-step ANSI standard chromaticity region with a minimum of 80CRI, 2x3 die configuration, 3W power, 9.3V typical forward voltage.

2. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements. Voltage minimum and maximum values at the nominal drive current are guaranteed by 100% test.

3. Products tested under pulsed condition (10ms pulse width) at nominal drive current where $T_{sn} = 25$ °C.

4. Thermal resistance value was calculated using total electrical input power; optical power was not subtracted from input power.

Absolute Maximum Ratings

Table 5: Maximum Ratings

Parameter	Maximum Rating			
LED Junction Temperature (T _j)	125°C			
Storage Temperature	-40°C to +105°C			
Operating Solder Point Temperature (T_{sp})	-40°C to +105°C			
Soldering Temperature	260°C or lower for a maximum of 10 seconds			
Maximum Drive Current	480mA			
Maximum Peak Pulsed Forward Current ¹	600mA			
Maximum Reverse Voltage	Bridgelux LEDs are not designed to be driven in reverse bias			
Moisture Sensitivity Rating	MSL 3			
Electrostatic Discharge	2kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012			

Notes for Table 5:

1. Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating LED SMD at maximum peak pulsed current specified. Maximum peak pulsed current indicate values where LED SMD can be driven without catastrophic failures.

Product Bin Definitions

Table 6 lists the standard photometric luminous flux bins for Bridgelux SMD 5050 LEDs. Although several bins are listed, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all CCTs.

Table 6: Luminous Flux Bin Definitions at 320mA, T_{sp} =2	25°C
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Bin Code	Minimum	Maximum	Unit	Condition
A3	350	375		
A4	375	405		
A5	405	435	lm	I _F =320mA
A6	435	470		
A7	470	505		

Note for Table 6:

1. Bridgelux maintains a tolerance of ± 7.5% on luminous flux measurements.

Table 7: Forward Voltage	e Bin Defini	tion at 320mA,	T _{sp} =25℃
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Bin Code	Minimum	Maximum	Unit	Condition
CD	8.5	9.0		
CE	9.0	9.5	- V	L 220mA
CF	9.5	10.0		I _F =320mA
CG	10.0	10.5		

Note for Table 7:

1. Bridgelux maintains a tolerance of \pm 0.1V on forward voltage measurements.

Product Bin Definitions

сст	Color Succes	Center Point		Mojer Avie		Ellipse	Color Bin
	Color Space	Х	Y	Major Axis	Minor Axis	Rotation Angle	Color Bin
	3 SDCM	0.4578	0.4101	0.00810	0.00420	53.70	3
2700K	5 SDCM	0.4578	0.4101	0.01350	0.00700	53.70	5
	3 SDCM	0.4338	0.4030	0.00834	0.00408	53.22	3
3000K	5 SDCM	0.4338	0.4030	0.01390	0.00680	53.22	5
	3 SDCM	0.4103	0.3961	0.00927	0.00414	54.00	3
3500K	5 SDCM	0.4103	0.3961	0.01545	0.00690	54.00	5
	3 SDCM	0.3818	0.3797	0.00939	0.00402	53.72	3
4000K	5 SDCM	0.3818	0.3797	0.01565	0.00670	53.72	5
	3 SDCM	0.3611	0.3658	0.00756	0.00338	57.58	3
4500K	5 SDCM	0.3611	0.3658	0.01260	0.00563	57.58	5
	3 SDCM	0.3447	0.3553	0.00822	0.00354	59.62	3
5000K	5 SDCM	0.3447	0.3553	0.01370	0.00590	59.62	5
	3 SDCM	0.3287	0.3417	0.00746	0.00320	59.09	3
5700K	5 SDCM	0.3287	0.3417	0.01243	0.00533	59.09	5
0	3 SDCM	0.3123	0.3282	0.00669	0.00285	58.57	3
6500K	5 SDCM	0.3123	0.3282	0.01115	0.00475	58.57	5

Table 8: 3- and 5-step MacAdam Ellipse Color Bin Definitions

Notes for Table 8:

1. Color binning at T_{sp}=85°C

2. Bridgelux maintains a tolerance of \pm 0.007 on x and y color coordinates in the CIE 1931 color space.

Product Bin Definitions

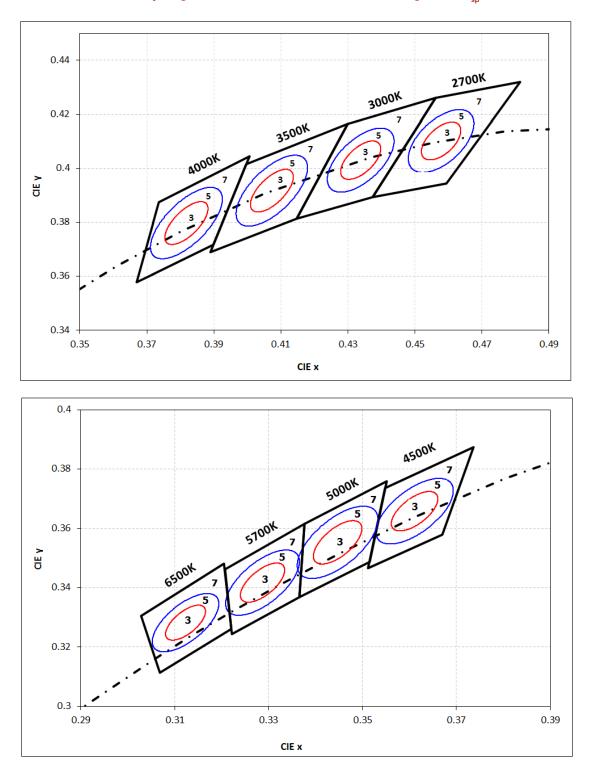
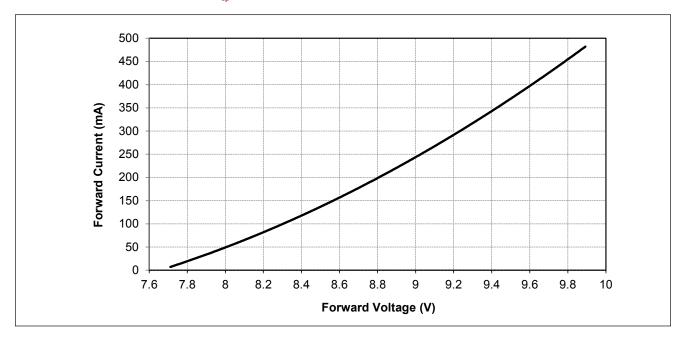


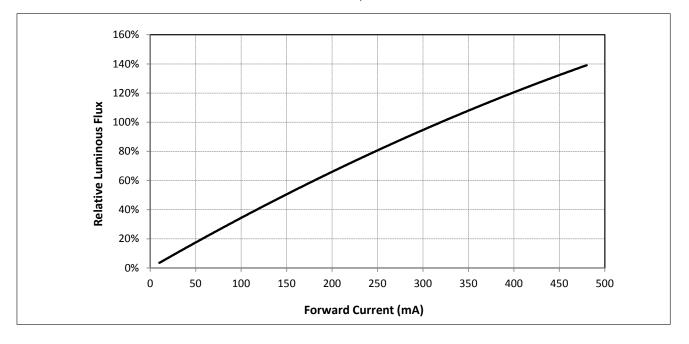
Figure 1: C.I.E. 1931 Chromaticity Diagram (3 Color Bin Structure, hot-color targeted at T_{sp} =85°C)

Performance Curves

Figure 2: Drive Current vs. Voltage (T_{sp}=25°C)







Note for Figure 3:

1. Bridgelux does not recommend driving high power LEDs at low currents. Doing so may produce unpredictable results. Pulse width modulation (PWM) is recommended for dimming effects.

Performance Curves

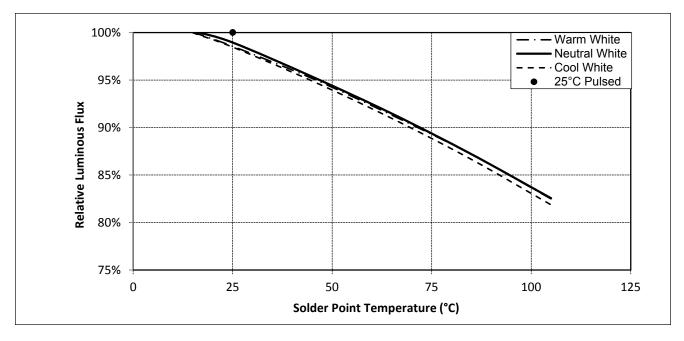
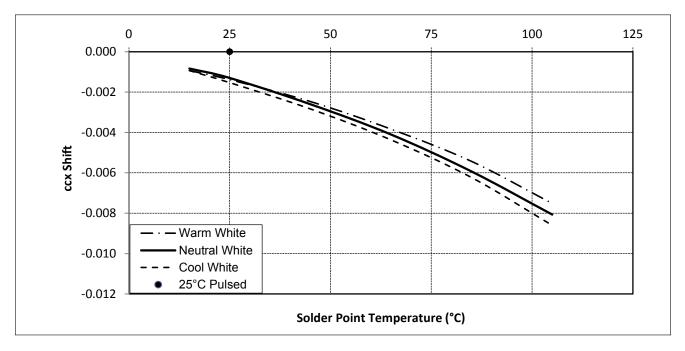


Figure 4: Typical Relative DC Flux vs. Solder Point Temperature





Notes for Figures 4 & 5:

4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

^{1.} Characteristics shown for warm white based on 3000K and 80 CRI.

^{2.} Characteristics shown for neutral white based on 4000K and 80 CRI.

^{3.} Characteristics shown for cool white based on 5000K and 80 CRI.

Performance Curves

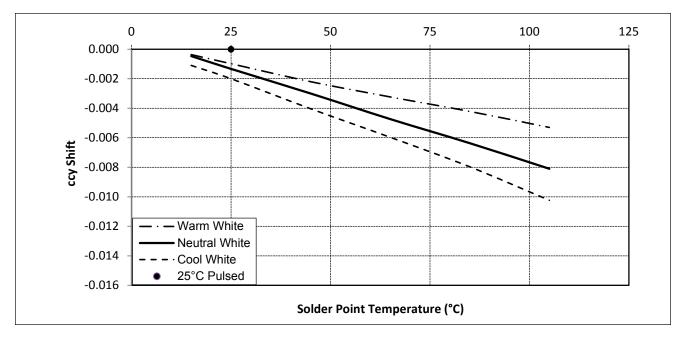


Figure 6: Typical DC ccy Shift vs. Solder Point Temperature

Notes for Figure 6:

1. Characteristics shown for warm white based on 3000K and 80 CRI.

2. Characteristics shown for neutral white based on 4000K and 80 CRI.

3. Characteristics shown for cool white based on 5000K and 80 CRI.

4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Typical Radiation Pattern

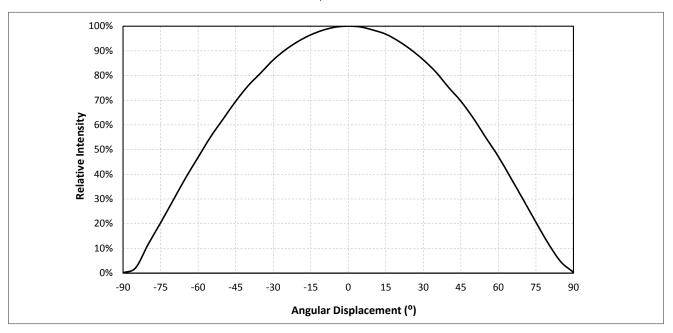


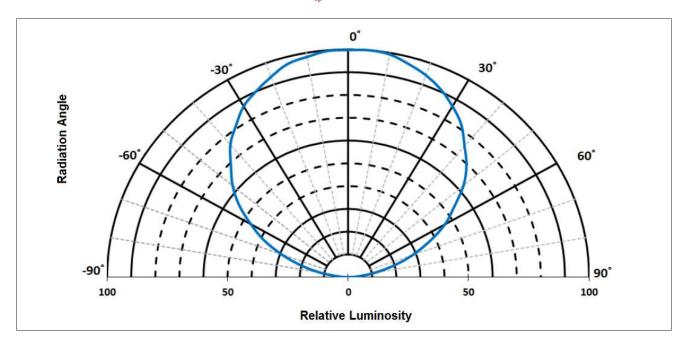
Figure 7: Typical Spatial Radiation Pattern at 320mA, T_{sp}=25°C

Notes for Figure 7:

1. Typical viewing angle is 116°.

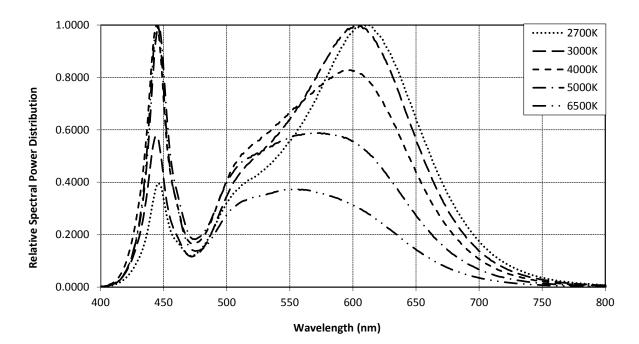
2. The viewing angle is defined as the off axis angle from the centerline where luminous intensity (Iv) is ½ of the peak value.

Figure 8: Typical Polar Radiation Pattern at 320mA, T_{sp}=25°C



Typical Color Spectrum

Figure 9: Typical Color Spectrum

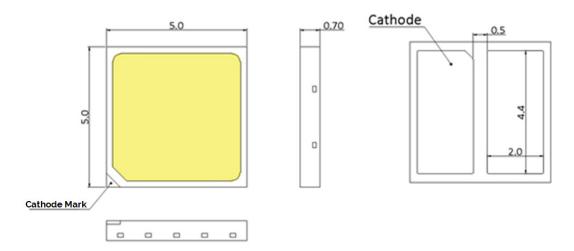


Notes for Figure 9:

- 1. Color spectra measured at nominal current for $T_{so} = 25^{\circ}C$
- 2. Color spectra shown for warm white is 2700K and 80 CRI.
- 3. Color spectra shown for warm white is 3000K and 80 CRI.
- 4. Color spectra shown for neutral white is 4000K and 80 CRI.
- 5. Color spectra shown for cool white is 5000K and 80 CRI.
- 6. Color spectra shown for cool white is 6500K and 80 CRI.

Mechanical Dimensions

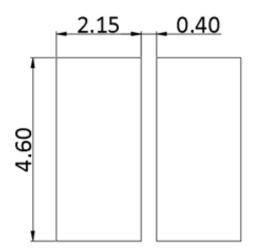
Figure 10: Drawing for SMD 5050



Notes for Figure 10:

- 1. Drawings are not to scale.
- 2. Drawing dimensions are in millimeters.
- 3. Unless otherwise specified, tolerances are ± 0.10mm.





Reliability

No .	Items	Reference Standard	Test Conditions	Drive Current	Test Duration	Units Failed/Tested
1	Moisture/Reflow Sensitivity	J-STD-020E	T _{std} = 260°C, 10sec, Precondition: 60°C, 60%RH, 168hr	-	3 reflows	0/22
2	Low Temperature Storage	JESD22-A119	T _a =-40°C	-	1000 hours	0/22
3	High Temperature Storage	JESD22-A103D	T _a = 105°C	-	1000 hours	0/22
4	Low Temperature Operating Life	JESD22-A108D	T _a =-40°C	320mA	1000 hours	0/22
5	Temperature Humidity Operating Life	JESD22-A101C	T _{sp} =85°C, RH=85%	320mA	1000 hours	0/22
6	High Temperature Operating Life	JESD22-A108D	T _{sp} =105°C	400mA	1000 hours	0/22
7	Power switching	IEC62717:2014	T _{sp} = 105°C 30 sec on, 30 sec off	400mA	30000 cycles	0/22
8	Thermal Shock	JESD22-A106B	T _a =-40°C ~100°C; Dwell : 15min; Transfer: 10sec	-	200 cycles	0/22
9	Temperature Cycle	JESD22-A104E	T _a =-40°C ~100°C; Dwell at extreme temperature: 15min; Ramp rate < 105°C/min	-	200 cycles	0/22
10	Electrostatic Discharge	JS-001-2012	HBM, 2KV, 15kΩ, 100pF, Alternately positive or negative	-	-	0/22

Table 9: Reliability Test Items and Conditions

Passing Criteria

ltem	Symbol	Test Condition	Passing Criteria
Forward Voltage	Vf	320mA	∆Vf<10%
Luminous Flux	Fv	320mA	Δ Fv<30%
Chromaticity Coordinates	(x, y)	320mA	∆u'v'<0.007

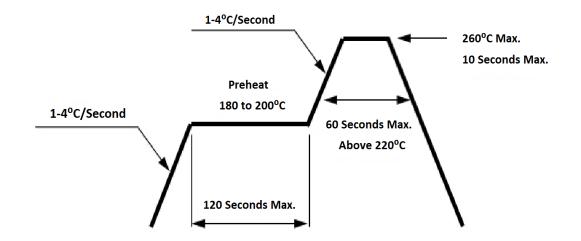
Notes for Table 9:

1. Measurements are performed after allowing the LEDs to return to room temperature

2. T_{sld} : reflow soldering temperature; T_a : ambient temperature

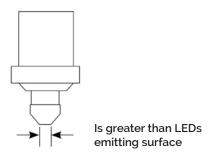
Reflowing Characteristics

Figure 11 : Reflow Profile



Profile Feature	Lead Free Assembly		
Preheat: Temperature Range	180°C – 200°C		
Preheat: Time (Maximum)	120 seconds		
Peak Temperature	260°C		
Soldering Time (Maximum)	10 seconds		
Allowable Reflow Cycles	2		

Figure 12 : Pick and Place

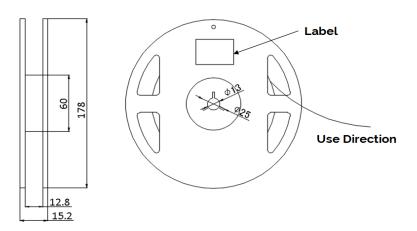


Note for Figure 12:

1. When using a pick and place machine, choose a nozzle that has a larger diameter than the LED's emitting surface. Using a Pick-and-Place nozzle with a smaller diameter than the size of the LEDs emitting surface will cause damage and may also cause the LED to not illuminate.

Packaging

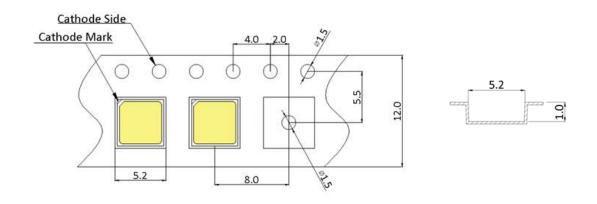
Figure 13: Emitter Reel Drawings

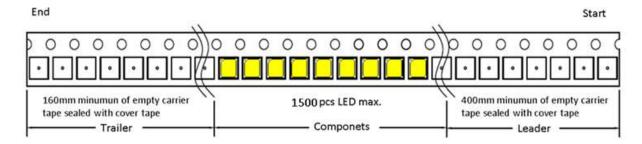


Note for Figure 13:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 14: Emitter Tape Drawings



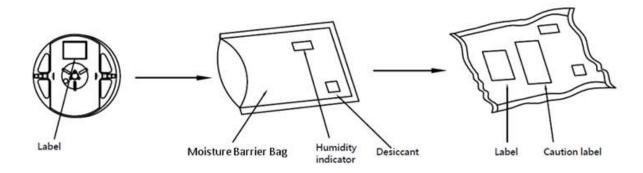


Note for Figure 14:

1. Drawings are not to scale. Drawing dimensions are in millimeters.



Figure 15: Emitter Reel Packaging Drawings



Note for Figure 15: 1. Drawings are not to scale.

Design Resources

Please contact your Bridgelux sales representative for assistance.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED emitter. Please consult Bridgelux Application Note AN51 for additional information.

CAUTION: EYE SAFETY

This SMD package emits visible light, that, under certain circumstances, could be harmful to the eye. Proper safe-guards must be used.

CAUTION: RISK OF BURN

Do not touch the SMD LED emitter during operation. Allow the emitter to cool for a sufficient period of time before handling. The SMD LED emitter may reach elevated temperatures such that could burn skin when touched.

CAUTION

CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the emitter or apply stress to the LES (yellow phosphor resin area). Contact may cause damage to the emitter

Optics and reflectors must not be mounted in contact with the LES (yellow phosphor resin area).

Disclaimers

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

STANDARD TEST CONDITIONS

Unless otherwise stated, LED emitter testing is performed at the nominal drive current.

About Bridgelux: We Build Light That Transforms

At Bridgelux, we help companies, industries and people experience the power and possibility of light. Since 2002, we've designed LED solutions that are high performing, energy efficient, cost effective and easy to integrate. Our focus is on light's impact on human behavior, delivering products that create better environments, experiences and returns—both experiential and financial. And our patented technology drives new platforms for commercial and industrial luminaires.

For more information about the company, please visit bridgelux.com twitter.com/Bridgelux facebook.com/Bridgelux WeChat ID: BridgeluxInChina



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